MOLDED POWER CHOKE COIL

PIB0512MP SERIES

1. PART NO. EXPRESSION :

P I B 0 5 1 2 M P 2 R 2 M N - □ □

(a) (b) (c) (d) (e) (f) (g)

(a) Series code

(b) Dimension code

(c) Type code

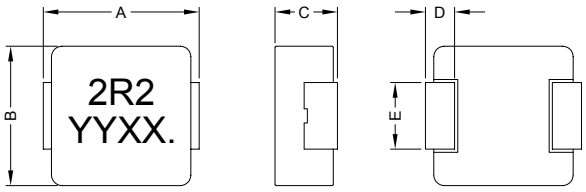
(d) Inductance code : 2R2 = 2.2uH

(e) Tolerance code : M = ± 20%, Y = ± 30%

(f) No coating

(g) Internal control number : 11 ~ 99

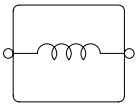
2. CONFIGURATION & DIMENSIONS :



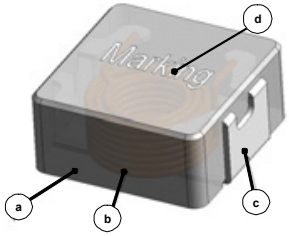
Unit:m/m

A	B	C	D	E
5.7± 0.3	5.2 ± 0.2	1.0± 0.2	1.1± 0.3	2.5± 0.3

3. SCHEMATIC :



4. MATERIALS :



(a) Core : Alloy metal powder or equivalent

(b) Wire : Polyester wire or equivalent

(c) Solder Plating : 100% Pb free solder

(d) Ink : Halogen-free ketone

5. GENERAL SPECIFICATION :

a) Test Freq. : L : 100KHz/1V

b) Ambient Temp. : 25° C

c) Operating Temp. : -40° C to +125° C

d) Storage Temp. : -10° C to +40° C

e) Humidity Range : 50 ~ 60% RH (Product without taping)

f) Heat Rated Current (Irms) : Will cause the coil temp. rise approximately Δt of 40°C (keep 1min.)

g) Saturation Current (Isat) : Will cause L0 to drop 30% typical (keep quickly)

h) Part Temperature (Ambient+Temp. Rise) : Should not exceed 125° C under worst case operating conditions.

HF
Halogen Free

Pb

RoHS Compliant

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25.02.2011

6. ELECTRICAL CHARACTERISTICS :

Part No.	Inductance L_0 (µH) @ 0 A	Irms (A) Typ.	Isat (A) Typ.	DCR (mΩ) ±10% Typ. @ 25° C
PIB0512MPR33MN	0.33 ± 20%	8	12	10
PIB0512MPR47MN	0.47 ± 20%	7	10	14.3
PIB0512MP2R2MN	2.20 ± 20%	3.5	4	71
PIB0512MP4R7MN	4.70 ± 20%	2.5	3	117
PIB0512MP5R6MN	5.60 ± 20%	2.2	2.8	185
PIB0512MP8R2MN	8.20 ± 20%	1.7	2.2	300
PIB0512MP100MN	10.0 ± 20%	1.5	2	345

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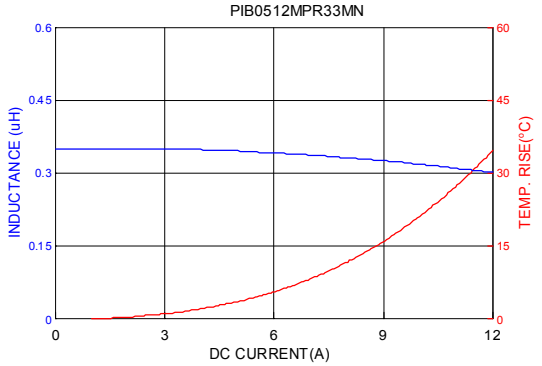
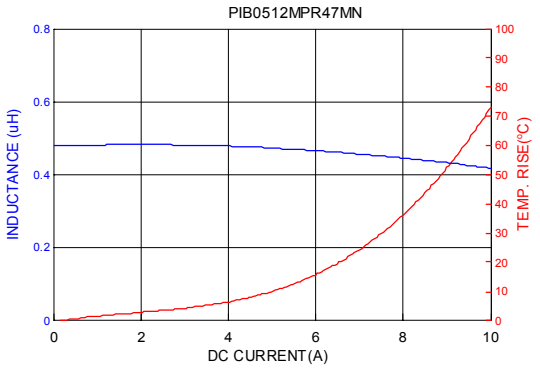
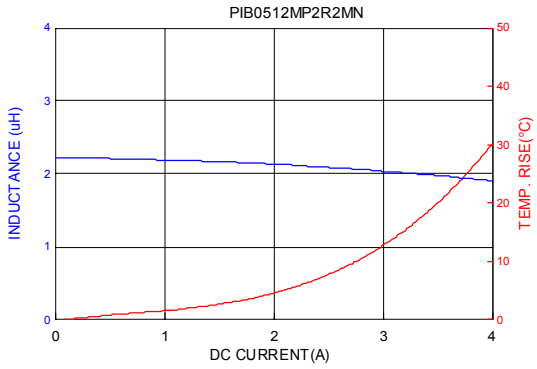
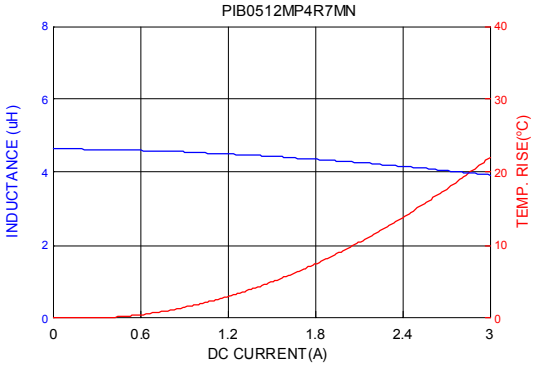
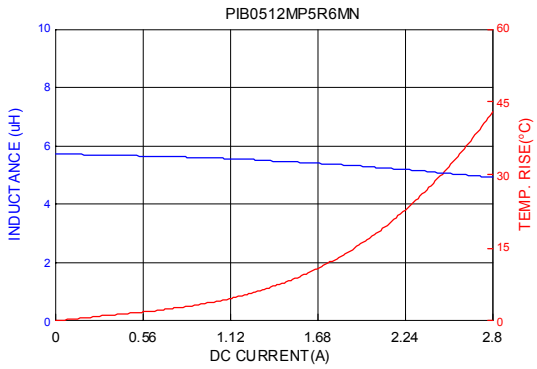
7. CHARACTERISTICS CURVES :

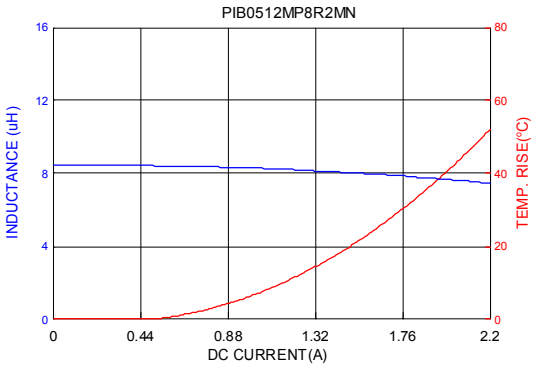












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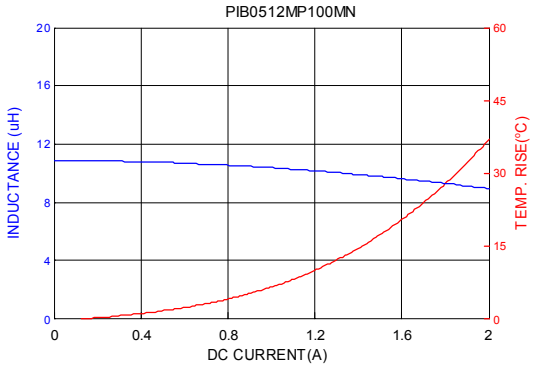

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8. RELIABILITY AND TEST CONDITION

<table>
<tr><th>ITEM</th><th>PERFORMANCE</th><th>TEST CONDITION</th></tr>
<tr><td colspan="3">Electrical Characteristics Test</td></tr>
<tr><td>Inductance</td><td rowspan="2">Refer to standard electrical characteristics list</td><td>HP4284A, CH11025, CH3302, CH1320, CH1320S
LCR meter.</td></tr>
<tr><td>DCR</td><td>CH16502, Agilent33420A Micro-Ohm Meter.</td></tr>
<tr><td>Heat Rated Current (Irms)</td><td></td><td>Irms(A) will cause the coil temperature rise
approximately ΔT of 40°C without core loss
1. Applied the allowed DC current(keep 1min).
2. Temperature measured by digital surface thermometer</td></tr>
<tr><td>Saturation Current (Isat)</td><td>ΔL30% typical</td><td>Isat(A) will cause Lo to drop</td></tr>
<tr><td colspan="3">Reliability Test</td></tr>
<tr><td>High
Temperature Test</td><td rowspan="6">Electric specification should be satisfied</td><td>Temperature : 125± 2° C
Time : 1000± 12hrs
Measured at room temperature after placing for 2 to 3hrs
(MIL-PRF-27)</td></tr>
<tr><td>Low
Temperature Test</td><td>Temperature : -40± 2° C
Time :500± 12hrs
Measured at room temperature after placing for 2 to 3hrs</td></tr>
<tr><td>Thermal Shock</td><td>Conditions of 1 cycle.
<table>
<tr><th>Step</th><th>Temperature (° C)</th><th>Times (min.)</th></tr>
<tr><td>1</td><td>-40+0/-2</td><td>15± 1</td></tr>
<tr><td>2</td><td>Room Temperature</td><td>Within ≦0.2</td></tr>
<tr><td>3</td><td>+125+2/-0</td><td>15± 1</td></tr>
</table>
Total : 300 cycles
Measure at room temperature after placing for 2 to 3 hrs.
(AEC-Q200-REV C)</td></tr>
<tr><td>Humidity Resistance</td><td>Temperature : 85± 2° C
Humidity : 85± 3% RH
Time : 1000± 12hrs
Measured at room temperature after placing for 2 to 3hrs
(AEC-Q200-REV C)</td></tr>
<tr><td>Random Vibration
Test</td><td>Frequency : 10-2000-10Hz for 20 min.
Amplitude: Parts mounted within 2" from any secure point
Directions and times : X, Y, Z directions for 20 min.
This cycle shall be performed 12 times in each of three
mutually perpendicular directions.
(Total 12hours).
(MIL-STD-202 Method 204 D Test condition B)</td></tr>
<tr><td>Reflow Test</td><td>Preheat : 150± 5° C
Duration : 5 minutes
Temperature : 260± 5° C, 20-40 seconds
(IPC/JEDEC J-STD-020C)</td></tr>
<tr><td>Solder test</td><td>Terminals should be covered by over 95%
solder on visual inspection.</td><td>After dip into flux，dip into solder
235± 5° C, 4± 1seconds
Flux, solder for lead free
(ANSI/J-STD-002C Method B)</td></tr>
</table>

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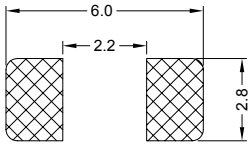
9. SOLDERING AND MOUNTING :

9-1. Recommended PC Board Pattern



9-2. Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

9-2.1 Solder Re-flow :

Recommended temperature profiles for re-flow soldering in Figure 1.

9-2.2 Soldering Iron (Figure 2) :

Products attachment with soldering iron is discouraged due to the inherent process control limitations.
In the event that a soldering iron must be employed the following precautions are recommended.
Note :

a) Preheat circuit and products to 150° C.
b) 355° C tip temperature (max)
c) Never contact the ceramic with the iron tip
d) 1.0mm tip diameter (max)
e) Use a 20 watt soldering iron with tip diameter of 1.0mm
f) Limit soldering time to 4-5 secs.

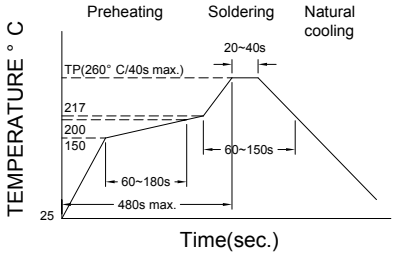


Figure 1. Re-flow Soldering

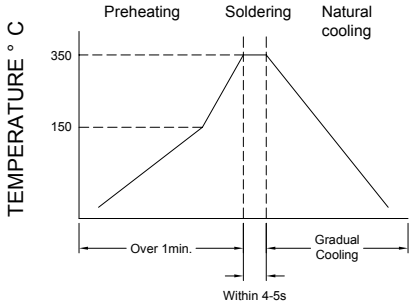


Figure 2. Iron Soldering

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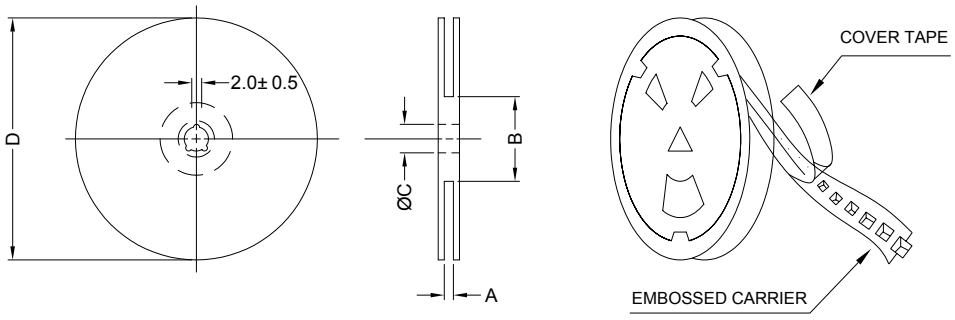
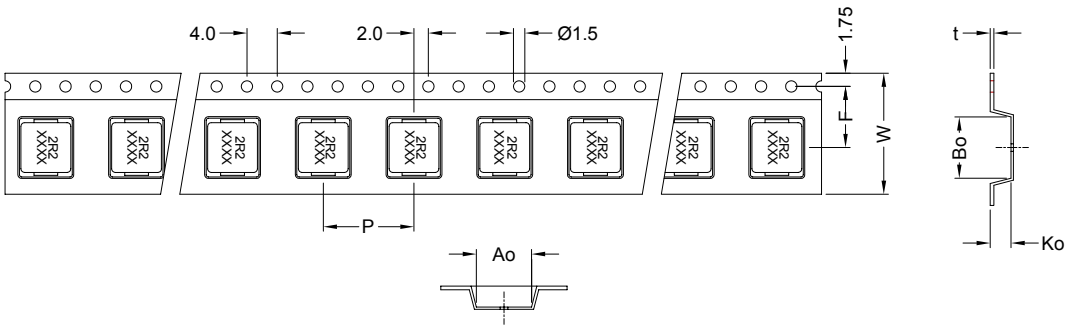
10. PACKAGING INFORMATION :

10-1. Reel Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)
13" x 12mm	12.0± 0.5	100± 2.0	13.5± 0.5	330

10-2 Tape Dimension



Series	Ao(mm)	Bo(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	t(mm)
PIB0512MP	5.5± 0.1	6.2± 0.1	1.5± 0.1	8.0± 0.1	12.0± 0.3	5.5± 0.1	0.35± 0.05

10-3. Packaging Quantity

Size	0512
Chip / Reel	4000
Inner Box	8000
Carton	32000

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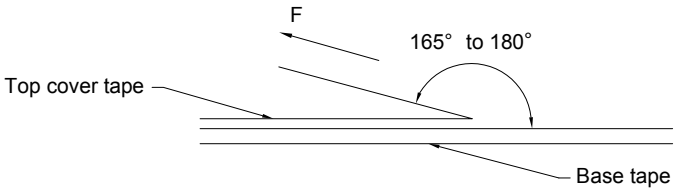
10-4. Tearing Off Force



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions. (referenced ANSI/EIA-481-C-2003 of 4.11 standard)

Room Temp. (° C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed (mm/min)
5~35	45~85	860~1060	300

Application Notice

1. Storage Conditions :
   To maintain the solderabililty of terminal electrodes :
   a) Temperature and humidity conditions : Less than 30° C and 70% RH.
   b) Recommended products should be used within 6 months from the time of delivery.
   c) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation :
   a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
   b) The use of tweezers or vacuum pick up is strongly recommended for individual components.
   c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

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